

## 1. General Description

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The EM74LVC1G332 is a single 3-input OR gate. Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V applications.

Schmitt trigger action at all inputs makes the circuit tolerant of slower input rise and fall time. This device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

## 2. Features and Benefits

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- Wide supply voltage range from 1.65 V to 5.5 V
- High noise immunity
- Overvoltage tolerant inputs to 5.5 V
- $\pm 24$  mA output drive ( $V_{CC} = 3.0$  V)
- CMOS low power dissipation
- Direct interface with TTL levels
- $I_{OFF}$  circuitry provides partial Power-down mode operation
- Latch-up performance exceeds 100 mA
- Complies with JEDEC standard:
  - JESD8-7 (1.65 V to 1.95 V)
  - JESD8-5 (2.3 V to 2.7 V)
  - JESD8C (2.7 V to 3.6 V)
  - JESD36 (4.5 V to 5.5 V)
- ESD protection:
  - HBM ANSI/ESDA/JEDEC JS-001 Class 3B exceeds 8000 V
  - MM JESD22-A115C Class C exceeds 550 V
  - CDM ANSI/ESDA/JEDEC JS-002 Class C3 exceeds 2000 V
- Multiple package options

# EM74LVC1G332

Single 3-input OR gate

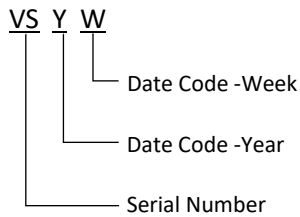
## 3. Ordering Information

Table 1. Ordering information

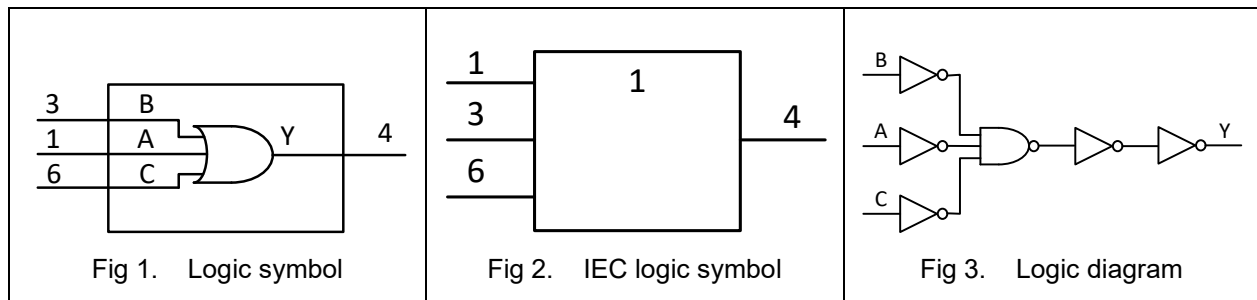
Type number	Topside marking	Package		
		Name	Description	Quantity
EM74LVC1G332GV	VSYW	SOT23-6L	SOT23 package, 6 pins 2.92 mm × 1.6 mm; 1.25 mm (Max) height	3000
EM74LVC1G332GW	VSYW	SOT363	SOT363 package, 6 pins 2.1 mm × 1.25 mm; 1.1 mm (Max) height	3000
EM74LVC1G332GS	VS	DFN1x1-6L	DFN1x1 package, 6 pins 1 mm × 1 mm; 0.42 mm (Max) height	3000
EM74LVC1G332GM	VSYW	DFN1x1.45-6L	DFN1.45x1 package, 6 pins 1.45 mm × 1 mm; 0.6 mm (Max) height	3000

### MARKING INFORMATION

NOTE: YW = Date Code.

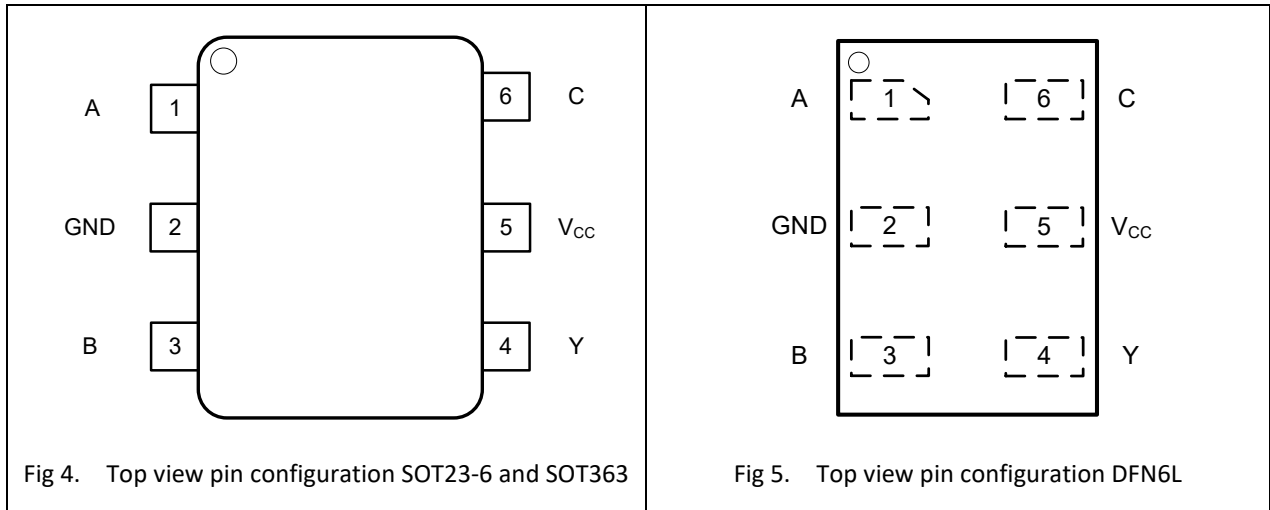


## 4. Function Diagram



## 5. Pinning Information

### 5.1. Pin map



### 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
A	1	Data input
GND	2	Ground (0V)
B	3	Data input
Y	4	Data output
V <sub>cc</sub>	5	Supply voltage
C	6	Data input

## 6. Functional Description

**Table 3. Function table**

H = HIGH voltage level; L = LOW voltage level; X = don't care.

Input			Output
A	B	C	Y
H	X	X	H
X	H	X	H
X	X	H	H
L	L	L	L

## 7. Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

**Table 4. Absolute Maximum Ratings**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND.

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	6.5	V
$I_{IK}$	input clamping current	$V_I < 0\text{ V}$	-50		mA
$V_I$	input voltage	[1]	-0.5	6.5	V
$I_{OK}$	output clamping current	$V_O > V_{CC}$ or $V_O < 0\text{ V}$		$\pm 50$	mA
$V_O$	output voltage	Active mode [1]	-0.5	$V_{CC} + 0.5$	V
		Power-down mode; $V_{CC} = 0\text{ V}$ [1]	-0.5	6.5	V
$I_O$	output current	$V_O = 0\text{ V}$ to $V_{CC}$		$\pm 50$	mA
$I_{CC}$	supply current			100	mA
$I_{GND}$	ground current		-100		mA
$P_{tot}$	total power dissipation	$T_{amb} = -40\text{ °C}$ to $+125\text{ °C}$		250	mW
$T_{stg}$	storage temperature		-65	150	°C

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

## 8. Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. EnergyMath does not recommend exceeding them or designing to Absolute Maximum Ratings.

**Table 5. Recommended Operating Conditions**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>CC</sub>	supply voltage		1.65		5.5	V
V <sub>I</sub>	input voltage		0		5.5	V
V <sub>O</sub>	output voltage	Active mode	0		V <sub>CC</sub>	V
		Power-down mode; V <sub>CC</sub> = 0 V	0		5.5	V
T <sub>amb</sub>	ambient temperature		-40		125	°C
Δt/ΔV	Input transition rise and fall rate	V <sub>CC</sub> = 1.65 V to 2.7 V			20	ns/V
		V <sub>CC</sub> = 2.7 V to 5.5 V			10	ns/V

## 9. Static Characteristics

**Table 6. Static characteristics**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
$V_{IH}$	HIGH-level input voltage	$V_{CC} = 1.65\text{ V to }1.95\text{ V}$	$0.65V_{CC}$			$0.65V_{CC}$		V
		$V_{CC} = 2.3\text{ V to }2.7\text{ V}$	1.7			1.7		V
		$V_{CC} = 2.7\text{ V to }3.6\text{ V}$	2.0			2.0		V
		$V_{CC} = 4.5\text{ V to }5.5\text{ V}$	$0.7V_{CC}$			$0.7V_{CC}$		V
$V_{IL}$	LOW-level input voltage	$V_{CC} = 1.65\text{ V to }1.95\text{ V}$			$0.35V_{CC}$		$0.35V_{CC}$	V
		$V_{CC} = 2.3\text{ V to }2.7\text{ V}$			0.7		0.7	V
		$V_{CC} = 2.7\text{ V to }3.6\text{ V}$			0.8		0.8	V
		$V_{CC} = 4.5\text{ V to }5.5\text{ V}$			$0.3V_{CC}$		$0.3V_{CC}$	V
$V_{OH}$	HIGH-level output voltage	$V_I = V_{IH}\text{ or }V_{IL}$						
		$I_O = -100\mu\text{A}; V_{CC} = 1.65\text{ V to }5.5\text{ V}$	$V_{CC} - 0.1$			$V_{CC} - 0.1$		V
		$I_O = -4\text{ mA}; V_{CC} = 1.65\text{ V}$	1.2	1.54		0.95		V
		$I_O = -8\text{ mA}; V_{CC} = 2.3\text{ V}$	1.9	2.15		1.7		V
		$I_O = -12\text{ mA}; V_{CC} = 2.7\text{ V}$	2.2	2.50		1.9		V
		$I_O = -24\text{ mA}; V_{CC} = 3.0\text{ V}$	2.3	2.62		2.0		V
		$I_O = -32\text{ mA}; V_{CC} = 4.5\text{ V}$	3.8	4.11		3.4		V
$V_{OL}$	LOW-level output voltage	$V_I = V_{IH}\text{ or }V_{IL}$						
		$I_O = 100\mu\text{A}; V_{CC} = 1.65\text{ V to }5.5\text{ V}$			0.10		0.10	V
		$I_O = 4\text{ mA}; V_{CC} = 1.65\text{ V}$		0.07	0.45		0.70	V
		$I_O = 8\text{ mA}; V_{CC} = 2.3\text{ V}$		0.12	0.30		0.45	V
		$I_O = 12\text{ mA}; V_{CC} = 2.7\text{ V}$		0.17	0.40		0.60	V
		$I_O = 24\text{ mA}; V_{CC} = 3.0\text{ V}$		0.33	0.55		0.80	V
		$I_O = 32\text{ mA}; V_{CC} = 4.5\text{ V}$		0.39	0.55		0.80	V
$I_i$	Input leakage current	$V_I = 5.5\text{ V or GND}; V_{CC} = 0\text{ V to }5.5\text{ V}$		$\pm 0.1$	$\pm 1$		$\pm 1$	$\mu\text{A}$

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Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
$I_{OFF}$	power-off leakage current	$V_{CC} = 0V$ ; $V_I$ or $V_O = 5.5V$		$\pm 0.1$	$\pm 2$		$\pm 2$	$\mu A$
$I_{CC}$	supply current	$V_I = 5.5V$ or GND ; $I_O = 0A$ ; $V_{CC} = 1.65V$ to $5.5V$		0.1	4		4	$\mu A$
$\Delta I_{CC}$	additional supply current	per pin ; $V_{CC} = 2.3V$ to $5.5V$ ; $V_I = V_{CC} - 0.6V$ ; $I_O = 0A$		5	500		500	$\mu A$
$C_i$	input capacitance	$V_{CC} = 3.3V$ ; $V_I = GND$ to $V_{CC}$		5				pF

[1] All typical values are measured at  $V_{CC} = 3.3V$  and  $T_{amb} = 25^\circ C$ .

## 10. Dynamic Characteristics

**Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 7.

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
$t_{pd}$	propagation delay	A,B,C to Y; see Fig. 6 [2]						
		$V_{CC} = 1.65V$ to $1.95V$	3.4	9.4	15.9	3.4	16.3	ns
		$V_{CC} = 2.3V$ to $2.7V$	2.4	5.0	8.6	2.4	9.1	ns
		$V_{CC} = 3.0V$ to $3.6V$	1.8	3.9	6.0	1.8	6.3	ns
		$V_{CC} = 4.5V$ to $5.5V$	1.4	2.6	3.6	1.4	3.8	ns
$C_{PD}$	power dissipation capacitance	$V_I = GND$ to $V_{CC}$ ; $V_{CC} = 3.3V$ [3]		24				pF

[1] Typical values are measured at  $T_{amb} = 25^\circ C$  and  $V_{CC} = 1.8V, 2.5V, 3.3V$  and  $5.0V$  respectively.

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

$f_i$  = input frequency in MHz;

$f_o$  = output frequency in MHz;

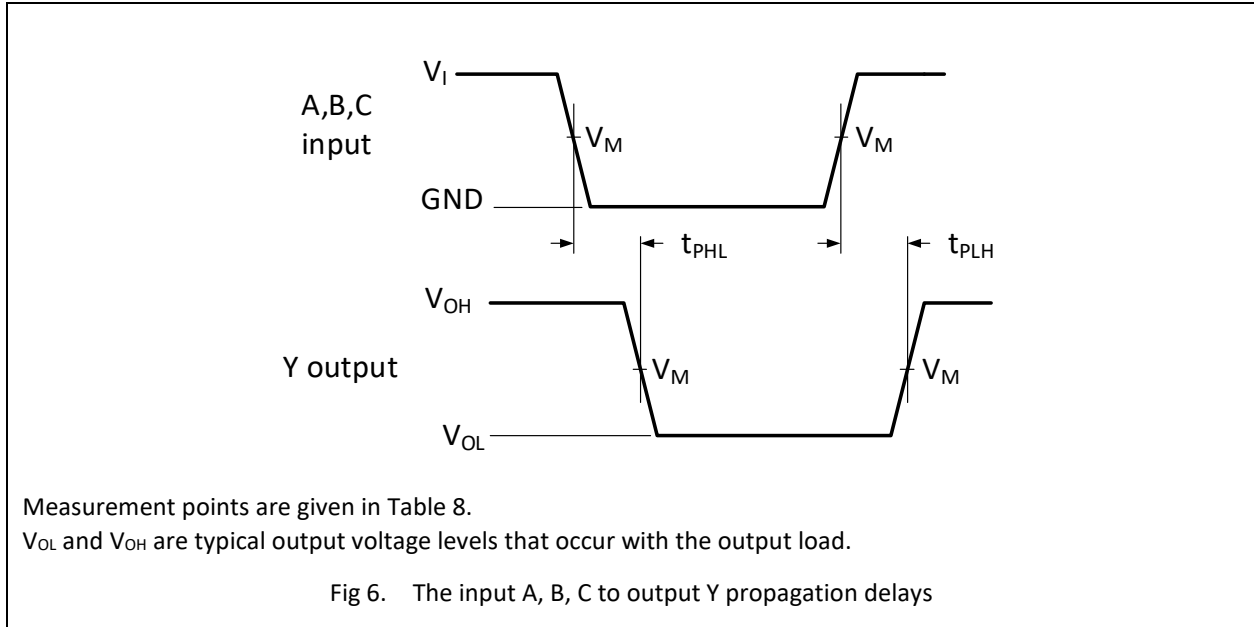
$C_L$  = output load capacitance in pF;

$V_{CC}$  = supply voltage in V;

$N$  = number of inputs switching;

$\sum (C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

### 10.1. Waveforms and test circuit

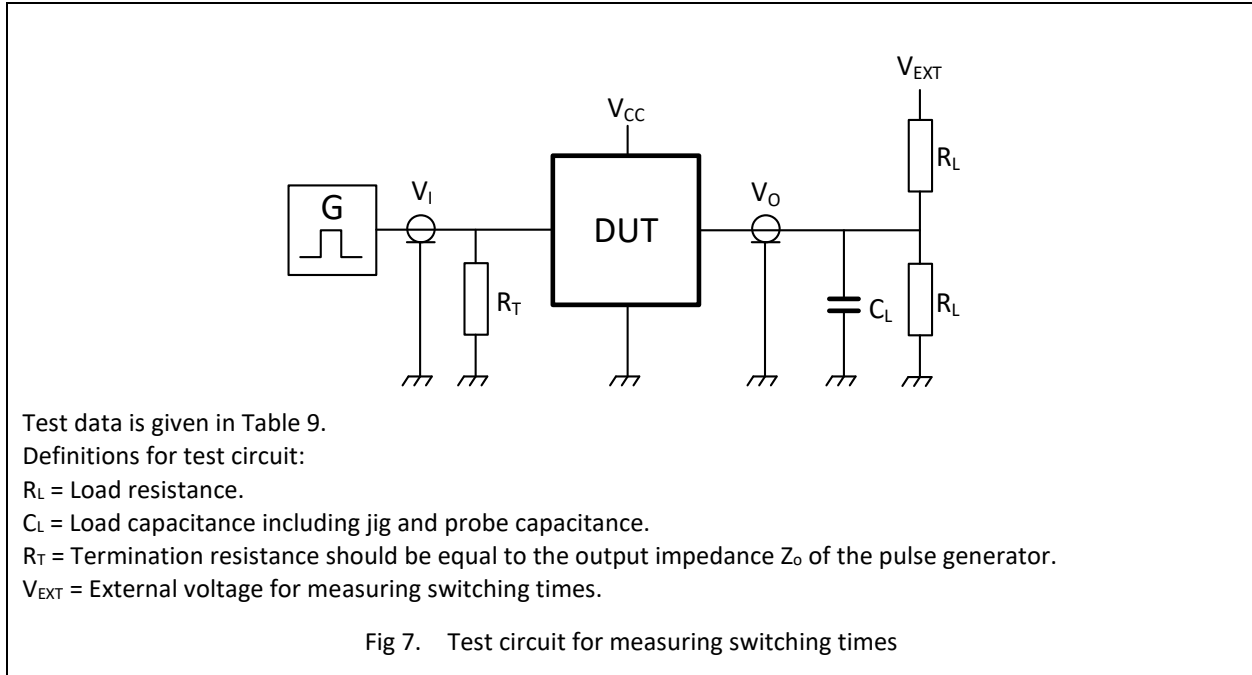


**Table 8. Measurement points**

Supply voltage	Input	Output
$V_{CC}$	$V_M$	$V_M$
1.65 V to 1.95 V	$0.5V_{CC}$	$0.5V_{CC}$
2.3 V to 2.7 V	$0.5V_{CC}$	$0.5V_{CC}$
3.0 V to 3.6 V	1.5 V	1.5 V
4.5 V to 5.5 V	$0.5V_{CC}$	$0.5V_{CC}$

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## Single 3-input OR gate

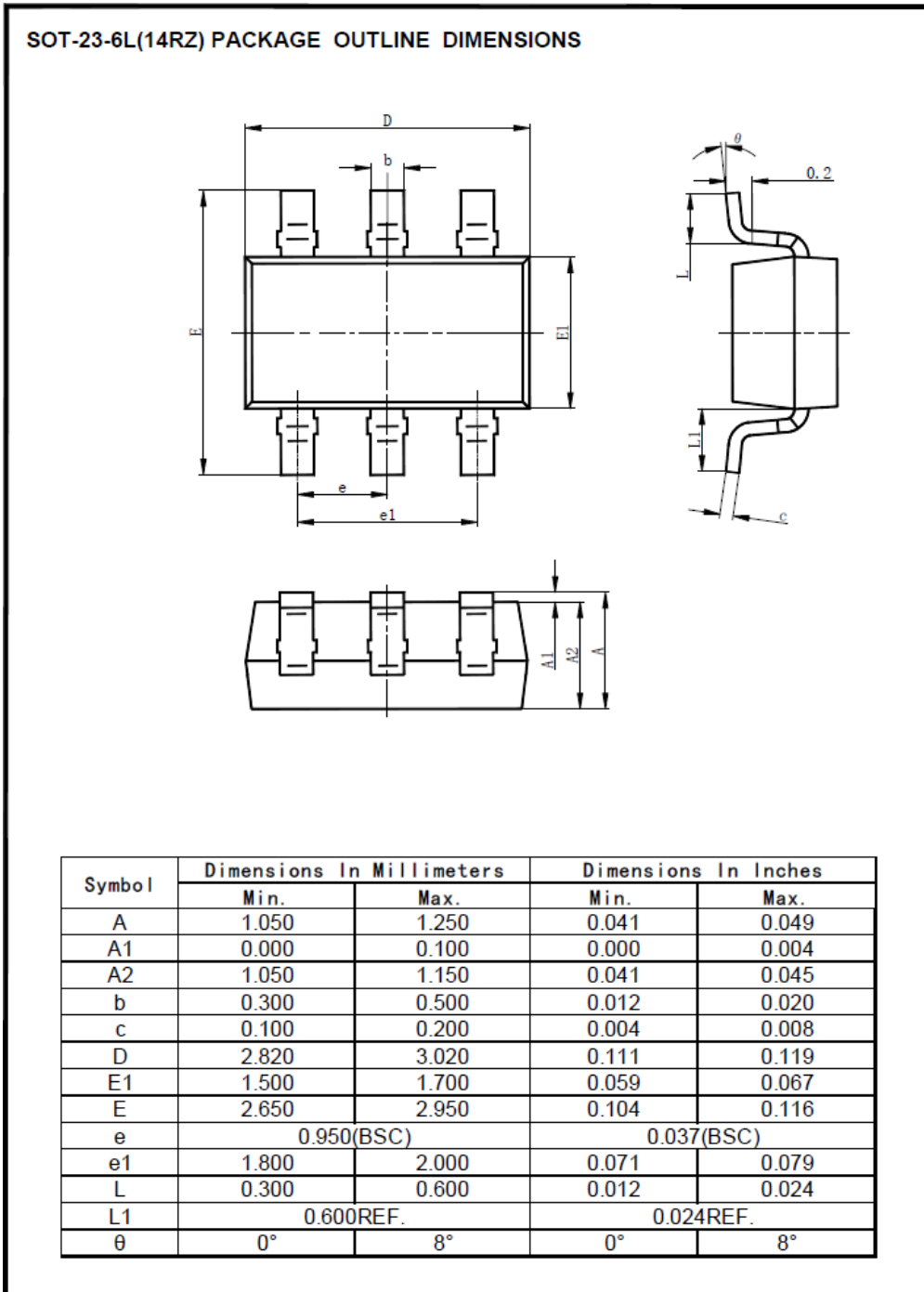


**Table 9. Test data**

Supply voltage	Input		Load		$V_{EXT}$
$V_{CC}$	$V_I$	$t_r = t_f$	$C_L$	$R_L$	$t_{PLH}, t_{PHL}$
1.65 V to 1.95 V	$V_{CC}$	$\leq 2.0$ ns	30 pF	1 k $\Omega$	open
2.3 V to 2.7 V	$V_{CC}$	$\leq 2.0$ ns	30 pF	500 $\Omega$	open
3.0 V to 3.6 V	3 V	$\leq 2.5$ ns	50 pF	500 $\Omega$	open
4.5 V to 5.5 V	$V_{CC}$	$\leq 2.5$ ns	50 pF	500 $\Omega$	open

# 11. Package Outline

SOT23-6L

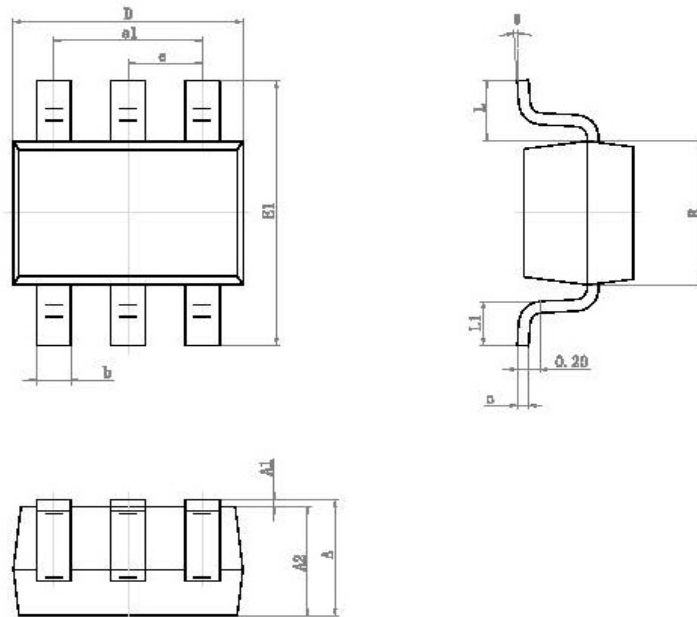


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Single 3-input OR gate

SOT363

**SOT-363 (16R) PACKAGE OUTLINE DIMENSIONS**

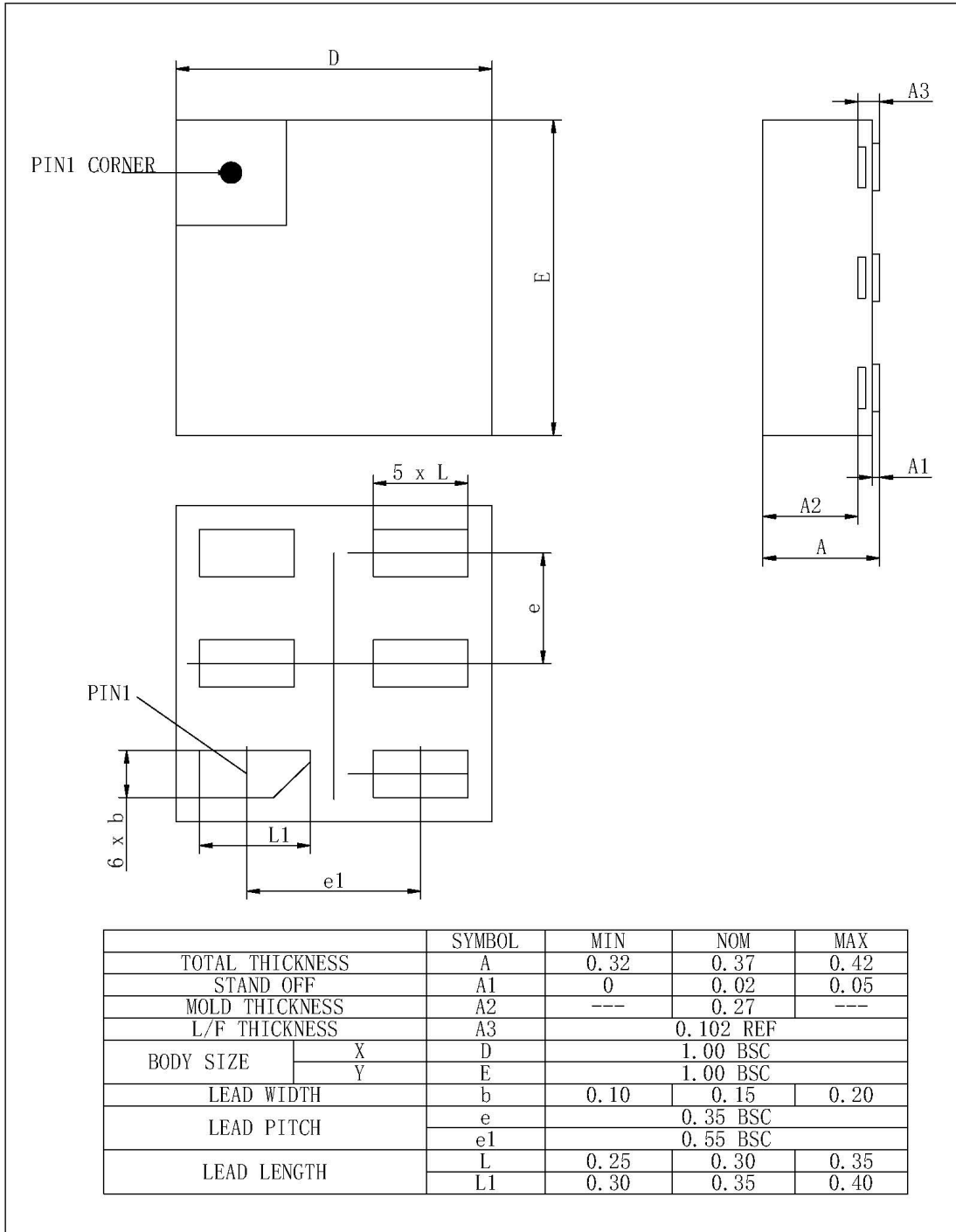


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
c	0.110	0.175	0.004	0.007
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650 TYP.		0.026 TYP.	
e1	1.200	1.400	0.047	0.055
L	0.525 REF.		0.021 REF.	
L1	0.260	0.460	0.010	0.018
$\theta$	0°	8°	0°	8°

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Single 3-input OR gate

## DFN1x1-6L





## 12. Tape and Reel Information

### 12.1. Carrier tape dimensions

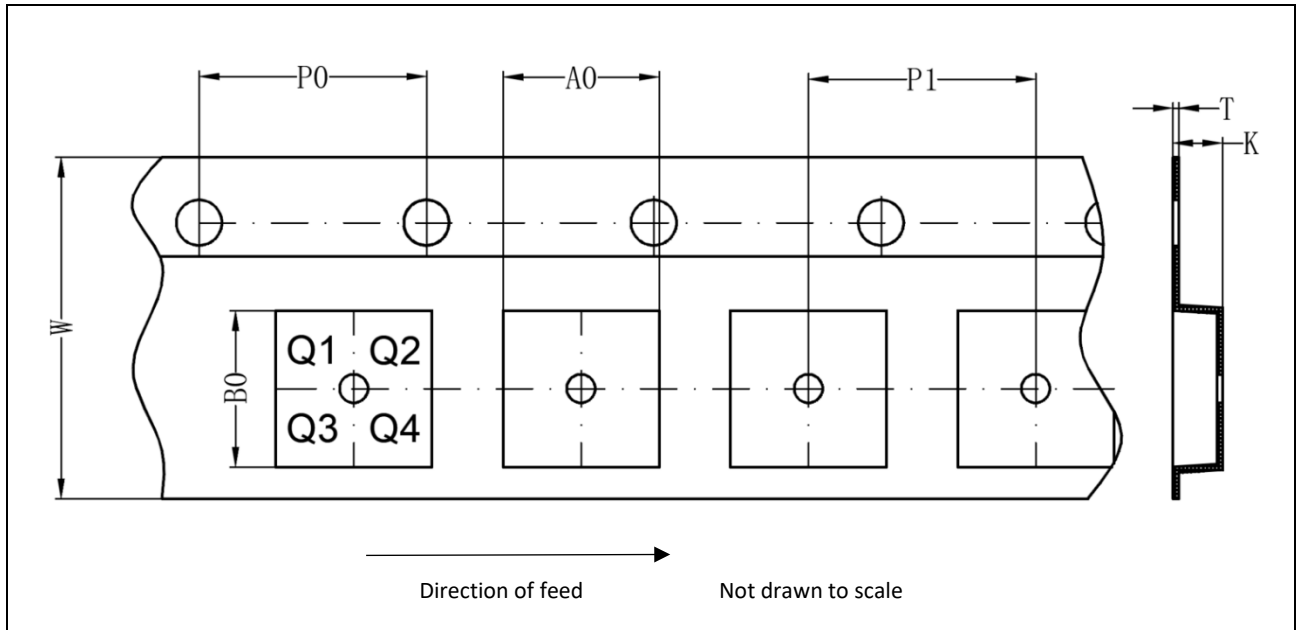
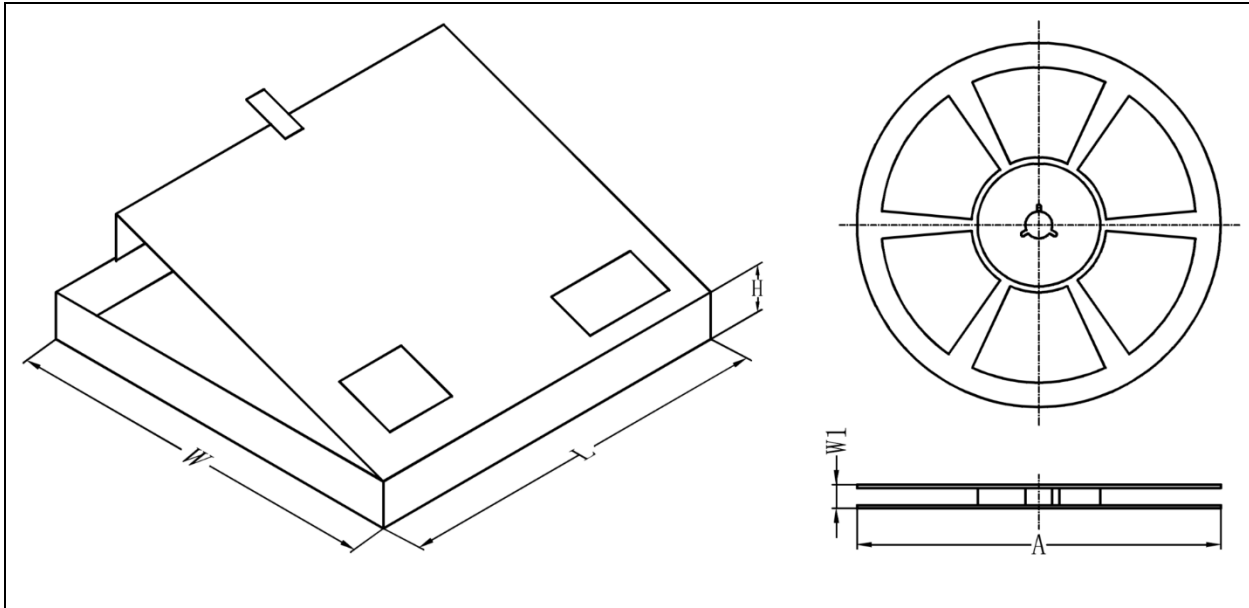


Table 10. Carrier tape dimensions

Package version	A0(mm)	B0(mm)	K(mm)	T(mm)	P1(mm)	W(mm)	P0(mm)	PIN 1
SOT23-6L	3.23	3.17	1.37	0.25	4	8	4	Q3
SOT363	2.55	2.55	1.2	0.2	4	8	4	Q3
DFN1x1-6L	1.16	1.16	0.5	0.23	4	8	4	Q1
DFN1x1.45-6L	1.15	1.6	0.75	0.2	4	8	4	Q1

## 12.2. Reel and box dimensions



**Table11. Dimensions and quantities**

Package version	Type NO. ending	Reel Dimension A (mm)	Reel Width W1 (mm)	SPQ (pcs)[1]	Reels per box	Outer box dimensions L×W×H(mm)[2]
SOT23-6L	GV	180	12.2	3000	1	210x200x40
SOT363	GW	180	12.2	3000	1	210x200x40
DFN1x1-6L	GS	180	12.2	3000	1	210x200x40
DFN1x1.45-6L	GM	180	12.2	3000	1	210x200x40

[1] Packing quantity dependent on specific product type. Please contact your local Energymath representative for ordering.

[2] Dimensions for reference only.

## 13. Abbreviations

**Table 12. Abbreviations**

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	Electro Static Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

## 14. Revision History

**Table 13. Revision history**

Document ID	Release Date	Data sheet status	Change notice	Supersedes
EM74LVC1G332 Rev1.1	Dec 15, 2025	Product datasheet		EM74LVC1G332 Rev1.0
Modifications:	<ul style="list-style-type: none"> <li>• Table 1: Added topside marking information.</li> <li>• Section 12: Added tape and reel information.</li> </ul>			
EM74LVC1G332 Rev1.0	Oct 30, 2023	Product datasheet		